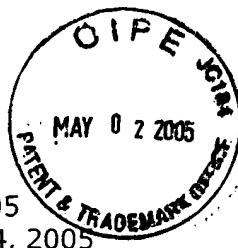


Appln. No.: 09/379,985
Amendment Dated April 29, 2005
Reply to Office Action of March 4, 2005



EN995137B

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appln. No: 09/379,985
Applicant: Eric Arthur Johnson
Filed: August 24, 1999
Title: THERMALLY ENHANCED FLIP CHIP PACKAGE AND METHOD OF FORMING
TC/A.U.: 2822
Examiner: Kevin M. Picardat
Confirmation No.: 2022
Docket No.: EN9951237B

RESPONSE

Mail Stop Reissue
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Responsive to the Office Action dated March 5, 2005, please reconsider allowance of the above application.

- ☐ **Amendments to the Specification** begin on page _____ of this paper.
- ☐ **Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.
- ☐ **Amendments to the Drawings** begin on page _____ of this paper and include an attached replacement sheet(s).
- ☐ **Amendments to the Abstract** are on page _____ of this paper. A clean version of the Abstract is on page _____ of this paper.
- ☒ **Remarks/Arguments** begin on page 2 of this paper.